

## **SSC8121GN1**

#### P-Channel Enhancement Mode MOSFET

#### Features

V <sub>DS</sub>	V <sub>GS</sub>	R <sub>DS(ON)</sub> Typ.	ID
		150mΩ@-4V5	
-20V	±8V	190mΩ@-2V5	-1A
		255mΩ@-1V8	

#### Description

This device is produced with high cell density DMOS trench technology, which is especially used to minimize on-state resistance. This device particularly suits low voltage applications such as portable equipment, power management and other battery powered circuits, and low in-line power dissipation are needed in a very small outline surface mount package.

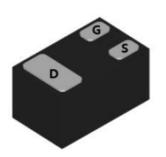
## Applications

- Load Switch
- Portable Devices
- DCDC conversion

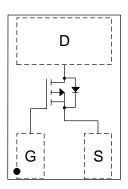
## > Ordering Information

Device	Package	Shipping
SSC8121GN1	DFN1006-3L	10000/Reel

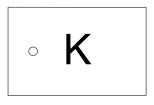
### Pin configuration



**DFN1006-3L (Bottom View)** 



Pin Configuration (Top View)



Marking



### ➤ Absolute Maximum Ratings (T<sub>A</sub>=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit
V <sub>DSS</sub>	Drain-to-Source Voltage	-20	V
V <sub>GSS</sub>	Gate-to-Source Voltage	±8	V
I <sub>D</sub>	Continuous Drain Current <sup>a</sup>	-1	Α
Ірм	Pulsed Drain Current <sup>b</sup>	-5	Α
P <sub>D</sub>	Power Dissipation <sup>c</sup>	0.45	W
P <sub>DSM</sub>	Power Dissipation <sup>a</sup>	0.3	W
TJ	Operation junction temperature	-55~150	$^{\circ}$
T <sub>STG</sub>	Storage temperature range	-55~150	$^{\circ}$

# ➤ Thermal Resistance Ratings (T<sub>A</sub>=25°C unless otherwise noted)

Symbol	Parameter	Maximum	Unit
R <sub>θJA</sub>	Junction-to-Ambient Thermal Resistance a	416	°C AA/
Rejc	Junction-to-Case Thermal Resistance	266	°C/W

#### Note:

- a. The value of R<sub>θJA</sub> is measured with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz.copper, in a still air environment with T<sub>A</sub>=25°C. The value in any given application depends on the user is specific board design. The power dissipation is based on the t≤10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.
- c. The power dissipation P<sub>D</sub> is based on T<sub>J(MAX)</sub>=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.

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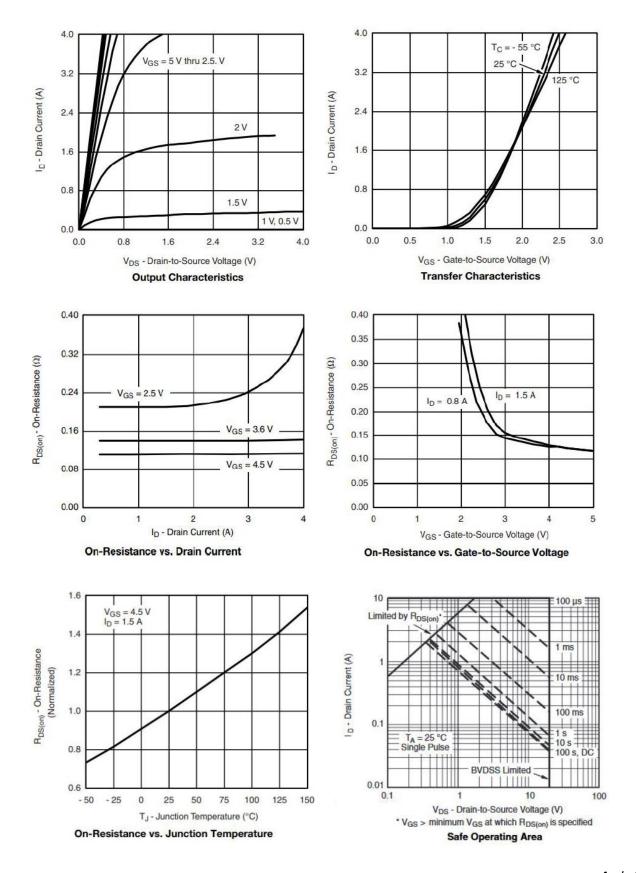


# $\succ$ Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

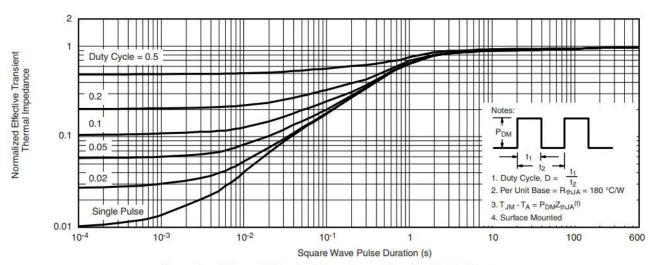
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250μA	-20			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = -250uA$	-0.45	-0.75	-1.5	V
	R <sub>DS(on)</sub>	$V_{GS} = -4.5V$ , $I_{D} = -0.45A$		150	350	mΩ
Drain-Source On-Resistance		V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -0.35A		190	450	
		V <sub>GS</sub> = -1.8V, I <sub>D</sub> = -0.25A		255	700	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = -20V, V <sub>GS</sub> = 0V			-1	μA
Gate-Source Leak Current	I <sub>GSS</sub>	$V_{GS} = \pm 8V$ , $V_{DS} = 0V$			±100	nA
Transconductance	GFS	V <sub>DS</sub> = -5V, I <sub>D</sub> = -1.4A		6.5		s
Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> = 0V, I <sub>S</sub> = -1A	-0.5	-0.7	-1.2	V
Input Capacitance	Ciss	V 0V V 0V		376	420	
Output Capacitance	Coss	$V_{DS} = -6V$ , $V_{GS} = 0V$ ,		187	205	pF
Reverse Transfer Capacitance	Crss	f = 1MHz		78	90	
Turn-on Delay Time	T <sub>D(ON)</sub>			13		
Rise Time	Tr	V <sub>GS</sub> = -6V, V <sub>GEN</sub> = -4.5V,		8		
Turn-off Delay Time	T <sub>D(OFF)</sub>	$R_L = 6\Omega$ , $R_G = 6\Omega$ , $I_D = -1A$		42		ns
Fall Time	T <sub>f</sub>	1D = -1A		10		



## ➤ Typical Performance Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

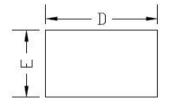




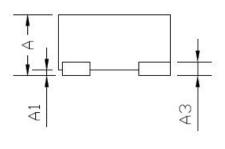


Normalized Thermal Transient Impedance, Junction-to-Ambient

# > Package Information



TOP VIEW



SIDE VIEW

e | 1 | 0 |

BOTTOM VIEW

PKG	DFN1006			
REF.	MIN.	NDM.	MAX	
Α	>0.4	0.77	0,50	
A1	0,00	/ <del>-</del>	0.05	
A3	0.125REF.			
D	0.95	1.00	1.05	
E	0.55	0.60	0.65	
b	0.20	0.25	0.30	
b1	0,20	0.30	0,40	
L	0.45	0.50	0.55	
L1	0.10	0,15	0.20	
6	0,675			
e1	0,35			



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